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(54) DYNAMICALLY RECONFIGURABLE CAPACITIVE SENSOR ARRAY

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| | H03K 17/98 | (2006.01) |

(52) U.S. Cl.

(58) Field of Classification Search

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| USPC | 341/20, 21, 33 | | |
| See application file for complete search history. | | | |

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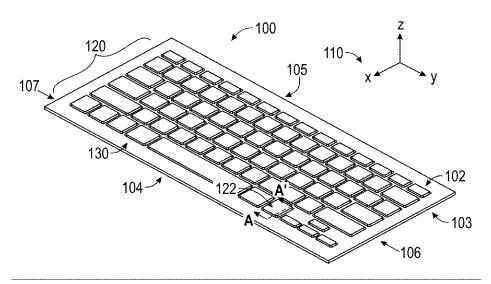
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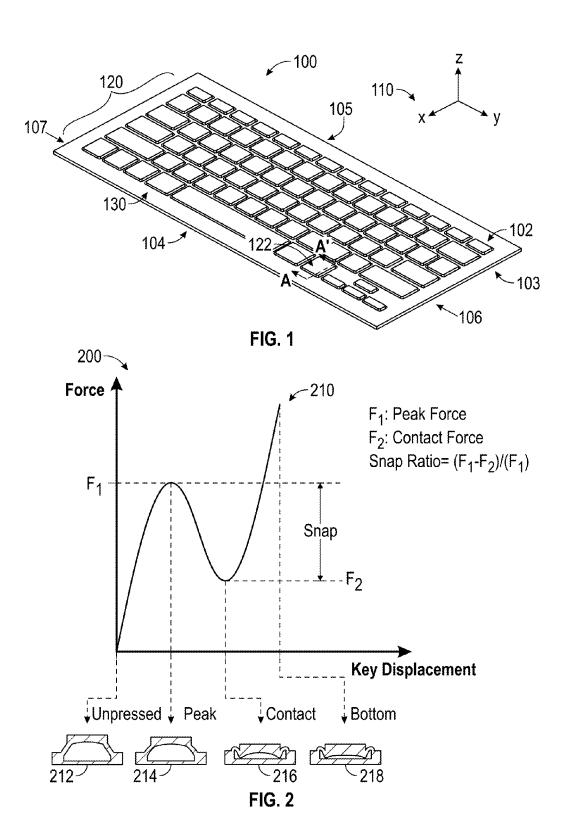
Primary Examiner — Amine Benlagsir (74) Attorney, Agent, or Firm — Osha Liang LLP

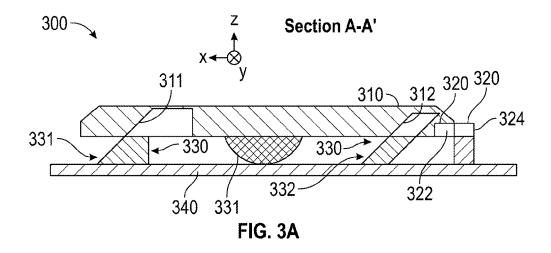
(57) ABSTRACT

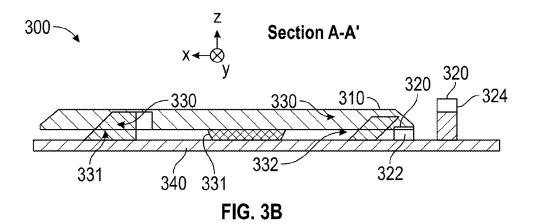
In a keyboard of the type including a key cap and a capacitive sensor disposed underneath the key cap, a method including operating the capacitive sensor in a first mode configured for near field detection and generating a first variable capacitance, and operating the capacitive sensor in a second mode configured for far field detection and generating a second variable capacitance. The method further includes determining key motion based on the first variable capacitance and determining finger presence based on the second variable capacitance.

15 Claims, 6 Drawing Sheets









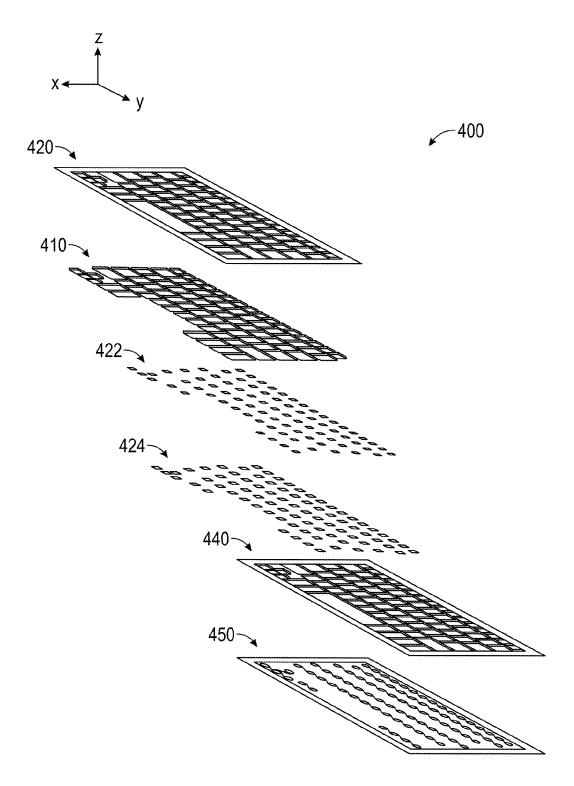


FIG. 4

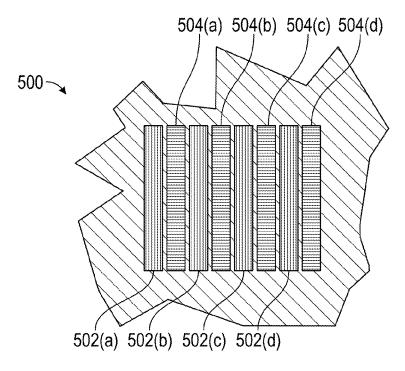


FIG. 5

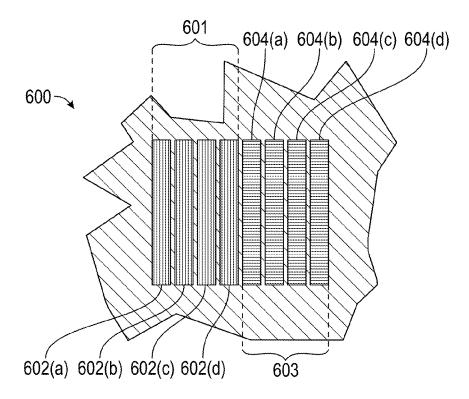


FIG. 6

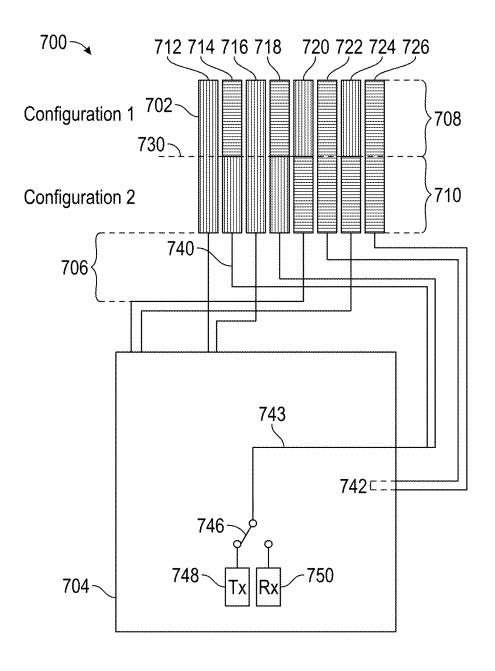


FIG. 7

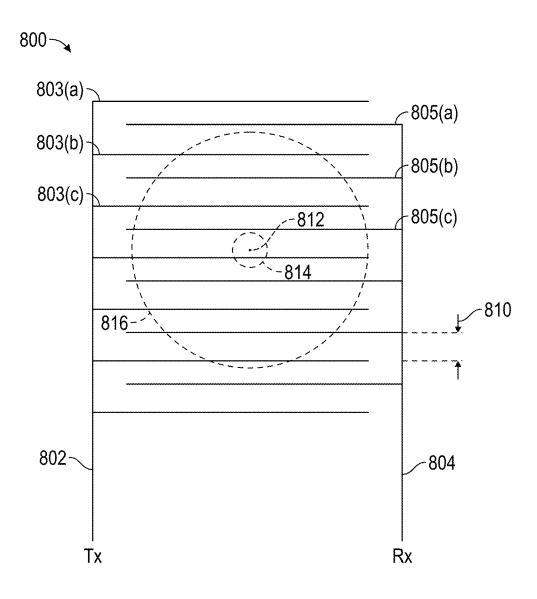


FIG. 8

DYNAMICALLY RECONFIGURABLE CAPACITIVE SENSOR ARRAY

FIELD OF THE INVENTION

This invention generally relates to electronic devices.

BACKGROUND OF THE INVENTION

Pressable touchsurfaces (touch surfaces which can be ¹⁰ pressed) are widely used in a variety of input devices, including as the surfaces of keys or buttons for keypads or keyboards, and as the surfaces of touch pads or touch screens. It is desirable to improve the usability of these input systems.

FIG. 2 shows a graph 200 of an example tactile response curve associated with the "snapover" haptic response found in many keys enabled with metal snap domes or rubber domes. Specifically, graph 200 relates force applied to the user by a touchsurface of the key and the amount of key 20 displacement (movement relative to its unpressed position). The force applied to the user may be a total force or the portion of the total force along a particular direction such as the positive or negative press direction. Similarly, the amount of key displacement may be a total amount of key 25 travel or the portion along a particular direction such as the positive or negative press direction.

The force curve 210 shows four key press states 212, 214, 216, 218 symbolized with depictions of four rubber domes at varying amounts of key displacement. The key is in the 30 "unpressed" state 212 when no press force is applied to the key and the key is in the unpressed position (i.e., "ready" position). In response to press input, the key initially responds with some key displacement and increasing reaction force applied to the user. The reaction force increases 35 with the amount of key displacement until it reaches a local maximum "peak force" F₁ in the "peak" state 214. In the peak state 214, the metal snap dome is about to snap or the rubber dome is about to collapse. The key is in the "contact" state 216 when the keycap, snap dome or rubber dome, or 40 other key component moved with the keycap makes initial physical contact with the base of the key (or a component attached to the base) with the local minimum "contact force" F₂. The key is in the "bottom" state 218 when the key has travelled past the "contact" state and is mechanically bot- 45 toming out, such as by compressing the rubber dome in keys enabled by rubber domes.

A snapover response is defined by the shape of the reaction force curve—affected by variables such as the rate of change, where it peaks and troughs, and the associated magnitudes. The difference between the peak force F_1 and the contact force F_2 can be termed the "snap." The "snap ratio" can be determined as $(F_1\text{-}F_2)/F_1$ (or as $100*(F_1\text{-}F_2)/F_1$, if a percent-type measure is desired).

Capacitive sensors for detecting a key press are well 55 known. Touch sensors for detecting finger presence are also well known. However, presently known key press sensors and finger presence sensors typically require separate, dedicated electrodes and associated circuitry for implementing the keystroke and proximity functions, respectively. 60 Devices, systems, and methods are thus needed which overcome this shortcoming.

BRIEF SUMMARY OF THE INVENTION

Methods and apparatus are provided for dynamically configuring a capacitive sensor array to selectively operate 2

in one of two sensitivity modes: i) a far field mode for detecting finger presence; and ii) a near field mode for detecting a keystroke which is relatively insensitive to finger presence. Various embodiments provide a processing system coupled to the sensor array for selectively switching blocks of electrodes between functioning as a group of transmitters in one sensitivity mode, and functioning as a group of receivers in the other sensitivity mode. By multiplexing the electrodes in this manner, the same sensing hardware and circuitry can be used to sense both keystroke and finger presence.

BRIEF DESCRIPTION OF DRAWINGS

Example embodiments of the present invention will hereinafter be described in conjunction with the appended drawings which are not to scale unless otherwise noted, where like designations denote like elements, and:

FIG. 1 shows an example keyboard that incorporates one or more implementations of key-based touchsurfaces configured in accordance with the techniques described herein;

FIG. 2 is a graph of an example tactile response that is characteristic of many keys enabled with metal snap domes or rubber domes;

FIGS. 3A-3B are simplified side views of a first example touchsurface assembly configured in accordance with the techniques described herein;

FIG. 4 shows an exploded view of an example keyboard in accordance with the techniques described herein;

FIG. 5 is a schematic layout diagram of a capacitive sensor array configured for near field sensing in accordance with the techniques described herein;

FIG. 6 is a schematic layout diagram of the capacitive sensor array of FIG. 5, shown dynamically reconfigured for far field sensing in accordance with the techniques described berein:

FIG. 7 is a schematic layout diagram of the capacitive sensor array of FIGS. 5 and 6 coupled to a processing system in accordance with the techniques described herein; and

FIG. **8** is a schematic diagram of an exemplary capacitive sensor configured for near field sensing, shown superimposed with a graphical representation of an increasing area of contact with a dielectric material in accordance with the techniques described herein.

DETAILED DESCRIPTION OF THE INVENTION

reaction force curve—affected by variables such as the rate of change, where it peaks and troughs, and the associated magnitudes. The difference between the peak force F₁ and the magnitudes. The difference between the peak force F₁ and the magnitudes are the peak force F₂ and the magnitudes.

Various embodiments of the present invention provide input devices and methods that facilitate improved usability, thinner devices, easier assembly, lower cost, more flexible industrial design, or a combination thereof. These input devices and methods involve pressable touchsurfaces that may be incorporated in any number of devices. As some examples, pressable touchsurfaces may be implemented as surfaces of touchpads, touchscreens, keys, buttons, and the surfaces of any other appropriate input device. Thus, some non-limiting examples of devices that may incorporate pressable touchsurfaces include personal computers of all sizes and shapes, such as desktop computers, laptop computers, netbooks, ultrabooks, tablets, e-book readers, personal digital assistants (PDAs), and cellular phones including smart phones. Additional example devices include data input devices (including remote controls, integrated key-

boards or keypads such as those within portable computers, or peripheral keyboards or keypads such as those found in tablet covers or stand-alone keyboards, control panels, and computer mice), and data output devices (including display screens and printers). Other examples include remote ter- 5 minals, kiosks, point-of-sale devices, video game machines (e.g., video game consoles, portable gaming devices, and the like) and media devices (including recorders, editors, and players such as televisions, set-top boxes, music players, digital photo frames, and digital cameras).

The discussion herein focuses largely on rectangular touchsurfaces. However, the touchsurfaces for many embodiments can comprise other shapes. Example shapes include triangles, quadrilaterals, pentagons, polygons with other numbers of sides, shapes similar to polygons with 15 rounded corners or nonlinear sides, shapes with curves, elongated or circular ellipses circles, combinations shapes with portions of any of the above shapes, non-planar shapes with concave or convex features, and any other appropriate shape.

In addition, although the discussion herein focuses largely on the touchsurfaces as being atop rigid bodies that undergo rigid body motion, some embodiments may comprise touchsurfaces atop pliant bodies that deform. "Rigid body motion" is used herein to indicate motion dominated by 25 translation or rotation of the entire body, where the deformation of the body is negligible. Thus, the change in distance between any two given points of the touchsurface is much smaller than an associated amount of translation or rotation of the body.

Also, in various implementations, pressable touchsurfaces may comprise opaque portions that block light passage, translucent or transparent portions that allow light passage,

a plurality of (two or more) pressable key-based touchsurfaces configured in accordance with the techniques described herein. The example keyboard 100 comprises rows of keys 120 of varying sizes surrounded by a keyboard bezel 130. Keyboard 100 has a QWERTY layout, even 40 though the keys 120 are not thus labeled in FIG. 1. Other keyboard embodiments may comprise different physical key shapes, key sizes, key locations or orientations, or different key layouts such as DVORAK layouts or layouts designed for use with special applications or non-English languages. 45 In some embodiments, the keys 120 comprise keycaps that are rigid bodies, such as rigid rectangular bodies having greater width and breadth than depth (depth being in the Z direction as explained below). Also, other keyboard embodiments may comprise a single pressable key-based touchsur- 50 face configured in accordance with the techniques described herein, such that the other keys of these other keyboard embodiments are configured with other techniques.

Orientation terminology is introduced here in connection with FIG. 1, but is generally applicable to the other discus- 55 sions herein and the other figures unless noted otherwise. This terminology introduction also includes directions associated with an arbitrary Cartesian coordinate system. The arrows 110 indicate the positive directions of the Cartesian coordinate system, but do not indicate an origin for the 60 coordinate system. Definition of the origin will not be needed to appreciate the technology discussed herein.

The face of keyboard 100 including the exposed touchsurfaces configured to be pressed by users is referred to as the "top" 102 of the keyboard 100 herein. Using the Carte- 65 sian coordinate directions indicated by the arrows 110, the top 102 of the keyboard 100 is in the positive-Z direction

relative to the bottom 103 of the keyboard 100. The part of the keyboard 100 that is typically closer to the body of a user when the keyboard 100 is in use atop a table top is referred to as the "front" 104 of the keyboard 100. In a QWERTY layout, the front 104 of the keyboard 100 is closer to the space bar and further from the alphanumeric keys. Using the Cartesian coordinate directions indicated by the arrows 110, the front 104 of the keyboard 100 is in the positive-X direction relative to the back 105 of the keyboard 100. In a typical use orientation where the top 102 of the keyboard 100 is facing upwards and the front 104 of the keyboard 100 is facing towards the user, the "right side" 106 of the keyboard 100 is to the right of a user. Using the Cartesian coordinate directions indicated by the arrows 110, the right side 106 of the keyboard 100 is in the positive-Y direction relative to the "left side" 107 of the keyboard 100. With the top 102, front 104, and right side 106 thus defined, the "bottom" 103, "back" 105, and "left side" 107 of the keyboard 100 are also defined.

Using this terminology, the press direction for the keyboard 100 is in the negative-Z direction, or vertically downwards toward the bottom of the keyboard 100. The X and Y directions are orthogonal to each other and to the press direction. Combinations of the X and Y directions can define an infinite number of additional lateral directions orthogonal to the press direction. Thus, example lateral directions include the X direction (positive and negative), the Y direction (positive and negative), and combination lateral directions with components in both the X and Y directions but not the Z direction. Motion components in any of these lateral directions is sometimes referred herein as "planar," since such lateral motion components can be considered to be in a plane orthogonal to the press direction.

Some or all of the keys of the keyboard 100 are configured FIG. 1 shows an example keyboard 100 that incorporates 35 to move between respective unpressed and pressed positions that are spaced in the press direction and in a lateral direction orthogonal to the press direction. That is, the touchsurfaces of these keys exhibit motion having components in the negative Z-direction and in a lateral direction. In the examples described herein, the lateral component is usually in the positive X-direction or in the negative X-direction for ease of understanding. However, in various embodiments, and with reorientation of select key elements as appropriate, the lateral separation between the unpressed and the pressed positions may be solely in the positive or negative X-direction, solely in the positive or negative Y-direction, or in a combination with components in both the X and Y direc-

> Thus, these keys of the keyboard 100 can be described as exhibiting "diagonal" motion from the unpressed to the pressed position. This diagonal motion is a motion including both a "Z" (or vertical) translation component and a lateral (or planar) translation component. Since this planar translation occurs with the vertical travel of the touchsurface, it may be called "planar translational responsiveness to vertical travel" of the touchsurface, or "vertical-lateral travel."

> Some embodiments of the keyboard 100 comprise keyboards with leveled keys that remain, when pressed during normal use, substantially level in orientation through their respective vertical-lateral travels. That is, the keycaps of these leveled keys (and thus the touchsurfaces of these keys) exhibit little or no rotation along any axes in response to presses that occur during normal use. Thus, there is little or no roll, pitch, and yaw of the keycap and the associated touchsurfaces remain relatively level and substantially in the same orientation during their motion from the unpressed position to the pressed position.

In various embodiments, the lateral motion associated with the vertical-lateral travel can improve the tactile feel of the key by increasing the total key travel for a given amount of vertical travel in the press direction. In various embodiments, the vertical-lateral travel also enhances tactile feel by imparting to users the perception that the touchsurface has travelled a larger vertical distance than actually travelled. For example, the lateral component of vertical-lateral travel may apply tangential friction forces to the skin of a finger pad in contact with the touchsurface, and cause deformation 10 of the skin and finger pad that the user perceives as additional vertical travel. This then creates a tactile illusion of greater vertical travel. In some embodiments, returning the key from the pressed to the unpressed position on the return stroke also involves simulating greater vertical travel using 15 lateral motion.

To enable the keys 120 of the keyboard 100 with verticallateral travel, the keys 120 are parts of key assemblies each comprising mechanisms for effecting planar translation, readying the key 120 by holding the associated keycap in the 20 unpressed position, and returning the key 120 to the unpressed position. Some embodiments further comprise mechanisms for leveling keycaps. Some embodiments achieve these functions with a separate mechanism for each function, while some embodiments achieve two or more of 25 these functions using a same mechanism. For example, a "biasing" mechanism may provide the readying function, the returning function, or both the readying and returning functions. Mechanisms which provide both readying and returning functions are referred to herein as "ready/return" 30 mechanisms. As another example, a leveling/planar-translation-effecting mechanisms may level and effect planar translation. As further examples, other combinations of functions may be provided by a same mechanism.

The keyboard 100 may use any appropriate technology 35 for detecting presses of the keys of the keyboard 100. For example, the keyboard 100 may employ a key switch matrix based on conventional resistive membrane switch technology. The key switch matrix may be located under the keys 120 and configured to generate a signal to indicate a key 40 press when a key 120 is pressed. Alternatively, the example keyboard 100 may employ other key press detection technology to detect any changes associated with the fine or gross change in position or motion of a key 120. Example key press detection technologies include various capacitive, 45 resistive, inductive, magnetic, force or pressure, linear or angular strain or displacement, temperature, aural, ultrasonic, optical, and other suitable techniques. With many of these technologies, one or more preset or variable thresholds may be defined for identifying presses and releases.

As a specific example, capacitive sensor electrodes may be disposed under the touchsurfaces, and detect changes in capacitance resulting from changes in press states of touchsurfaces. The capacitive sensor electrodes may utilize "self capacitance" (or "absolute capacitance") sensing methods 55 based on changes in the capacitive coupling between the sensor electrodes and the touchsurface. In some embodiments, the touch surface is conductive in part or in whole, or a conductive element is attached to the touchsurface, and held at a constant voltage such as system ground. A change 60 in location of the touchsurface alters the electric field near the sensor electrodes below the touchsurface, thus changing the measured capacitive coupling. In one implementation, an absolute capacitance sensing method operates with a capacitive sensor electrode underlying a component having the 65 touchsurface, modulates that sensor electrodes with respect to a reference voltage (e.g., system ground), and detects the

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capacitive coupling between that sensor electrode and the component having the touchsurface for gauging the press state of the touchsurface.

Some capacitive implementations utilize "mutual capacitance" (or "transcapacitance") sensing methods based on changes in the capacitive coupling between sensor electrodes. In various embodiments, the proximity of a touchsurface near the sensor electrodes alters the electric field between the sensor electrodes, thus changing the measured capacitive coupling. The touchsurface may be a conductive or non-conductive, electrically driven or floating, as long as its motion causes measurable change in the capacitive coupling between sensor electrodes. In some implementations, a transcapacitive sensing method operates by detecting the capacitive coupling between one or more transmitter sensor electrodes (also "transmitters") and one or more receiver sensor electrodes (also "receivers"). Transmitter sensor electrodes may be modulated relative to a reference voltage (e.g., system ground) to transmit transmitter signals. Receiver sensor electrodes may be held substantially constant relative to the reference voltage to facilitate receipt of resulting signals. A resulting signal may comprise effect(s) corresponding to one or more transmitter signals, and/or to one or more sources of environmental interference (e.g., other electromagnetic signals). Sensor electrodes may be dedicated transmitters or receivers, or may be configured to both transmit and receive.

In one implementation, a trans-capacitance sensing method operates with two capacitive sensor electrodes underlying a touchsurface, one transmitter and one receiver. The resulting signal received by the receiver is affected by the transmitter signal and the location of the touchsurface.

In some embodiments, the sensor system used to detect touchsurface presses may also detect pre-presses. For example, a capacitive sensor system may also be able to detect an input object hovering over but not contacting a touch surface. As another example, a capacitive sensor system may be able to detect an input object lightly touching a touchsurface, such that the user performs a non-press contact on the touchsurface, and does not depress the touchsurface sufficiently to be considered a press.

Some embodiments are configured to gauge the amount of force being applied on the touchsurface from the effect that the force has on the sensor signals. That is, the amount of depression of the touchsurface is correlated with one or more particular sensor readings, such that the amount of press force can be determined from the sensor reading(s). These types of systems can support multi-stage touchsurface input by distinguishing and responding differently to two or more of the following: non-contact hover, non-press contact, and one, two, or more levels of press.

In some embodiments, substrates used for sensing are also used to provide backlighting associated with the touchsurfaces. As a specific example, in some embodiments utilizing capacitive sensors underlying the touchsurface, the capacitive sensor electrodes are disposed on a transparent or translucent circuit substrate such as polyethylene terephthalate (PET), another polymer, or glass. Some of those embodiments use the circuit substrate as part of a light guide system for backlighting symbols viewable through the touchsurfaces.

FIG. 1 also shows a section line A-A' relative to the key 122 of the keyboard 100, which will be discussed below.

The keyboard 100 may be communicably coupled with a processing system 190 through communications channel 192. Connection 192 may be wired or wireless. The processing system 190 may comprise one or more ICs (inte-

grated circuits) having appropriate processor-executable instructions for operating the keyboard 100, such as instructions for operating key press sensors, processing sensor signals, responding to key presses, and the like. In some embodiments, the keyboard 100 is integrated in a laptop 5 computer or a tablet computer cover, and the processing system 190 comprises an IC containing instructions to operate keyboard sensors to determine the extent keys has been touched or pressed, and to provide an indication of touch or press status to a main CPU of the laptop or tablet 10 computer, or to a user of the laptop or tablet computer.

While the orientation terminology, vertical-lateral travel, sensing technology, and implementation options discussed here focuses on the keyboard 100, these discussions are readily analogized to other touchsurfaces and devices 15 described herein.

Various embodiments in accordance with the techniques described herein, including embodiments without metal snap domes or rubber domes, provide force response curves similar to the curve 210 of FIG. 2. Many tactile keyboard 20 keys utilize snap ratios no less than 0.4 and no more than 0.6. Other tactile keyboard keys may use snap ratios outside of these ranges, such as no less than 0.3 and no more than 0.5, and no less than 0.5 and no more than 0.7.

Other embodiments provide other response curves having 25 other shapes, including those with force and key travel relationships that are linear or nonlinear or which have constantly varying slopes. The force response curves may also be non-monotonic, monotonic, or strictly monotonic.

For example, the keys 120 made in accordance with the 30 techniques described herein may be configured to provide the response shown by curve 210, or any appropriate response curve. The reaction force applied to a user may increase linearly or nonlinearly relative to an amount of total key travel, an amount of key travel the press direction, or an 35 amount of key travel in a lateral direction. As a specific example, the force applied may increase with a constant slope relative to the amount of key travel for up to a first amount of force or key movement relative to its unpressed position, and then plateau (with constant force) or decrease 40 for up to a second amount of force or key movement.

FIGS. 3A-3B are simplified cross-sectional views of a first example touchsurface assembly. The key assembly 300 may be used to implement various keys, including the key 122 of the keyboard 100. In the embodiment where FIGS. 45 3A-3B depict the key 122, these figures illustrate A-A' sectional views of the key 122. FIG. 3A shows the example key assembly 300 including a resiliently deformable (e.g., rubber) dome 331 in an unpressed position, and FIG. 3B shows the same key assembly and rubber dome in a pressed 50 position. The key assembly 300 may also be used in other devices utilizing keys, including keyboards other than the keyboard 100 and any other appropriate key-using device. Further, assemblies analogous to the key assembly 300 may be used to enable non-key touchsurface assemblies such as 55 buttons, opaque touchpads, touchscreens, or any of the touchsurface assemblies described herein.

The key assembly 300 includes a keycap 310 that is visible to users and configured to be pressed by users, a ready/return mechanism 320, and a base 340. The unpressed 60 and pressed positions of the keycap 310 are spaced in a press direction and in a first lateral direction orthogonal to the press direction. The press direction is analogous to the key motion found in conventional keyboards lacking lateral key motion, is in the negative-Z direction, and is the primary 65 direction of press and key motion. In many keyboards the press direction is orthogonal to the touchsurface of the

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keycap or the base of the key, such that users would consider the press direction to be downwards toward the base.

The components of the key assembly 300 may be made from any appropriate material, including plastics such as polycarbonate (PC), acrylonitrile butadiene styrene (ABS), nylon, and acetal, metals such as steel and aluminum, elastomers such as rubber, and various other materials. In various embodiments, the keycap 310 is configured to be substantially rigid, such that the touchsurface of the keycap 310 appears to unaided human senses to move with rigid body motion between its unpressed and pressed positions during normal operation.

The ready/return mechanism 320 is a type of "biasing mechanism" that provides both readying and returning functions. The ready/return mechanism 320 physically biases the keycap 310 during at least part of the key press operation. It should be noted that a mechanism which only provides readying or returning function may also be termed a "biasing mechanism," if it biases the keycap 310 during at least part of the key press operation. The ready/return mechanism 320 is configured to hold the keycap 310 in its unpressed position so that the keycap 310 is ready to be pressed by a user. In addition, the ready/return mechanism 320 is also configured to return the keycap 310 partially or entirely to the unpressed position in response to a release of the press force to keycap **310**. The release of the press force may be a removal of the press force, or a sufficient reduction of press force such that the key assembly is able to return the keycap 310 to the unpressed position as a matter of normal operation. In the example embodiment of FIG. 3, the key assembly 300 utilizes magnetically coupled components 322, 324 to form the ready/return mechanism 320. Magnetically coupled components 322, 324 may both comprise magnets, or one may comprise a magnet while the other comprise a magnetically coupled material such as a ferrous material, a paramagnetic material, or a diamagnetic material. Although magnetically coupled components 322, 324 are each shown as a single rectangular shape, either or both magnetically coupled components 322, 324 may comprise non-rectangular cross-section(s) or comprise a plurality of magnetically coupled subcomponents having the same or different cross sections. For example, magnetically coupled component 322 or 324 may comprise a magnetic, box-shaped subcomponent disposed against a central portion of a ferrous, U-shaped subcomponent.

In some implementations, the magnetically coupled component 324 is physically attached to a bezel or base proximate to the keycap 310. The magnetically coupled component 322 is physically attached to the keycap and magnetically interacts with the magnetically coupled component 324. The physical attachment of the magnetically coupled components 322, 324 may be direct or indirect (indirectly being through one or more intermediate components), and may be accomplished by press fits, adhesives, or any other technique or combination of techniques. The amount of press force needed on the keycap to overcome the magnetic coupling (e.g., overpower the magnetic attraction or repulsion) can be customized based upon the size, type, shape, and positions of the magnetically coupling components 322, 324 involved.

The key assembly 300 comprises a planar-translation-effecting (PTE) mechanism 330 configured to impart planar translation to the keycap 310 when it moves between the unpressed and pressed positions, such that a nonzero component of lateral motion occurs. The PTE mechanism 330 is formed from parts of the keycap 310 and the base 340, and comprises four ramps (two ramps 331, 332 are visible in

FIGS. 3A-B) disposed on the base 340. These four ramps are located such that they are proximate to the corners of the keycap 310 when the key assembly 300 is assembled. In the embodiment shown in FIGS. 3A-B, these four ramps (including ramps 331, 332) are simple, sloped planar ramps located at an angle to the base 340. These four ramps (including ramps 331, 332) are configured to physically contact corresponding ramp contacting features (two ramp contacting features 311, 312 are visible in FIGS. 3A-B) disposed on the underside of the keycap 310. The ramp 10 contacting features of the keycap 310 may be any appropriate shape, including ramps matched to those of the ramps on the base 340.

In response to a press force applied to the touchsurface of the keycap 310 downwards along the press direction, the 15 ramps on the base 340 (including ramps 331, 332) provide reaction forces. These reaction forces are normal to the ramps and include lateral components that cause the keycap 310 to exhibit lateral motion. The ramps and some retention or alignment features that mate with other features in the 20 bezel or other appropriate component (not shown) help retain and level the keycap 310. That is, they keep the keycap 310 from separating from the ramps and in substantially the same orientation when travelling from the unpressed to the pressed position.

As shown by FIGS. 3A-B, the keycap 310 moves in the press direction (negative Z-direction) in response to a sufficiently large press force applied to the top of the keycap 310. As a result, the keycap 310 moves in a lateral direction (in the positive X-direction) and in the press direction (in the 30 negative Z-direction) due to the reaction forces associated with the ramps. The ramp contacting features (e.g., 311, 312) of the keycap 310 ride on the ramps of the base 340 (e.g., 331, 332) as the keycap 310 moves from the unpressed to the pressed position. This motion of the keycap 310 moves the 35 magnetically coupled components 322, 324 relative to each other, and changes their magnetic interactions.

FIG. 3B shows the keycap 310 in the pressed position. For the key assembly 300, the keycap 310 has moved to the pressed position when it directly or indirectly contacts the 40 base 340 or has moved far enough to be sensed as a key press. FIG. 3A-B do not illustrate the sensor(s) used to detect the press state of the keycap 310, and such sensor(s) may be based on any appropriate technology, as discussed above.

When the press force is released, the ready/return mechanism 320 returns the keycap 310 to its unpressed position. The attractive forces between the magnetically coupled components 322, 324 pull the keycap 310 back up the ramps (including the ramps 331, 322), toward the unpressed position.

Many embodiments using magnetic forces utilize permanent magnets. Example permanent magnets include, in order of strongest magnetic strength to the weakest: neodymium iron boron, samarium cobalt, alnico, and ceramic. Neodymium-based magnets are rare earth magnets, and are very 55 strong magnets made from alloys of rare earth elements. Alternative implementations include other rare earth magnets, non-rare earth permanent magnets, and electromagnets.

Although the key assembly 300 utilizes magnetically coupled components to form its ready/return mechanism 60 320, various other techniques can be used instead or in addition to such magnetic techniques in other embodiments. In addition, separate mechanisms may be used to accomplish the readying and returning functions separately. For example, one or more mechanisms may retain the keycap in 65 its ready position and one or more other mechanisms may return the keycap to its ready position. Examples of other

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readying, returning, or ready/return mechanisms include buckling elastomeric structures, snapping metallic domes, deflecting plastic or metal springs, stretching elastic bands, bending cantilever beams, and the like. In addition, in some embodiments, the ready/return mechanism push (instead of pull) the keycap 310 to resist keycap motion to the pressed position or to return it to the unpressed position. Such embodiments may use magnetic repulsion or any other appropriate technique imparting push forces.

Many variations of or additions to the components of the key assembly 300 are possible. For example, other embodiments may include fewer or more components. As a specific example, another key assembly may incorporate any number of additional aesthetic or functional components. Some embodiments include bezels that provide functions such as hiding some of the key assembly from view, protecting the other components of the key assembly, helping to retain or guide the touchsurface of the key assembly, or some other function

As another example, other embodiments may comprise different keycaps, readying mechanisms, returning mechanisms, PTE mechanisms, leveling mechanisms, or bases. As a specific example, the keycap 310, the base 340, or another component that is not shown may comprise protrusions, depressions, or other features that help guide or retain the keycap 310. As another specific example, some embodiments use non-ramp techniques in place or (or in addition to) ramps to effect planar translation. Examples other PTE mechanisms include various linkage systems, cams, pegs and slots, bearing surfaces, and other motion alignment features.

As yet another example, although the PTE mechanism 330 is shown in FIGS. 3A-B as having ramps disposed on the base 340 and ramp contacting features disposed on the keycap 310, other embodiments may have one or more ramps disposed on the keycap 310 and ramp contacting features disposed on the base 340. Also, the PTE mechanism 330 is shown in FIGS. 3A-B as having ramps 331, 332 with simple, sloped plane ramp profiles. However, in various embodiments, the PTE mechanism 330 may utilize other profiles, including those with linear, piecewise linear, or nonlinear sections, those having simple or complex curves or surfaces, or those including various convex and concave features. Similarly, the ramp contacting features on the keycap 310 may be simple or complex, and may comprise linear, piecewise linear, or nonlinear sections. As some specific examples, the ramp contacting features may comprise simple ramps, parts of spheres, sections of cylinders, and the like. Further, the ramp contacting features on the keycap 310 may make point, line, or surface contact the ramps on the base 340 (including ramps 331, 332). "Ramp profile" is used herein to indicate the contour of the surfaces of any ramps used for the PTE mechanisms. In some embodiments, a single keyboard may employ a plurality of different ramp profiles in order to provide different tactile responses for different keys.

As a further example, embodiments which level their touchsurfaces may use various leveling techniques which use none, part, or all of the associate PTE mechanism.

FIG. 4 shows an exploded view of an example keyboard construction 400 in accordance with the techniques described herein. A construction like the keyboard construction 400 may be used to implement any number of different keyboards, including keyboard 100. Proceeding from the top to the bottom of the keyboard, the bezel 420 comprises a plurality of apertures through which keycaps 410 of various sizes are accessible in the final assembly. Magnetically

coupled components 422, 424 are attached to the keycaps 410 or the base 440, respectively. The base 440 comprises a plurality of PTE mechanisms (illustrated as simple rectangles on the base 440) configured to guide the motion of the keycaps 410. Underneath the base 440 is a key sensor 450, 5 which comprises one or more layers of circuitry disposed on one or more substrates.

Various details have been simplified for ease of understanding. For example, adhesives that may be used to bond components together are not shown. Also, various embodiments may have more or fewer components than shown in keyboard construction 400, or the components may be in a different order. For example, the base and the key sensor 450 may be combined into one component, or swapped in the stack-up order.

FIG. 5 is a schematic layout diagram of a capacitive sensor array 500 configured for near field sensing in accordance with the techniques described herein. More particularly, the array 500 includes one or more transmitter electrodes 502(a), 502(b) . . . 502(d) interleaved with one or 20 more receiver electrodes 504(a), 504(b) . . . 504(d). In the near field arrangement shown in FIG. 5, the thickness and spacing of the electrodes are selected to be insensitive to conductive objects (such as a finger). This allows the sensor to function as a keystroke detector unencumbered by finger 25 proximity. In an embodiment, keystroke detection employs a deformable dielectric disposed between the key cap and the sensor. During a downward keystroke, the deformable dielectric (which has a higher dielectric constant than air) spreads out over the sensor surface, changing the capaci- 30 tance response of the sensor. This changing capacitance can be used to determine the amount of force applied to the key cap or, alternatively, whether the applied force meets or exceeds a threshold amount of force, to thereby detect a keystroke.

When it is desired to employ the sensor array as a far field sensor to detect finger presence, the sensor may be dynamically reconfigured to reallocate some of the transmitters as receiver, and vice-versa.

More particularly and referring now to FIG. 6, a schematic layout diagram of a capacitive sensor array 600 includes a block 601 of one or more adjacent transmitter electrodes 602(a), 602(b)... 602(d), and a block 603 of one or more adjacent receiver electrodes 604(a), 604(b)... 604(d). In the far field arrangement of FIG. 6, the block 601 45 of adjacent transmitters effectively functions as a single, relatively wide transmitter electrode, and the block 603 of adjacent receivers effectively functions as a single, relatively wide receiver electrode. This far field arrangement is particularly sensitive to conductive objects (e.g., a finger), and allows the sensor 600 to function as a proximity sensor due to the greater extent (relative to the configuration of FIG. 5) the field lines bridging the transmitter 601 and the receiver 603 extend into space.

FIG. 7 is a schematic layout diagram 700 of the capacitive 55 sensor array of FIGS. 5 and 6 coupled to a processing system in accordance with the techniques described herein. More particularly, the schematic layout diagram 700 includes a dynamically reconfigurable sensor array 702, a processing system 704, and lead lines 706 coupling the individual 60 electrodes of the sensor to respective terminals of the processing system.

The sensor array **702** includes a plurality of electrodes **712-726**, each connected to a corresponding terminal of a processing system (described in greater detail below). The 65 electrodes **712-726** may be alternately configured in a first configuration **708** (shown above a line **730**) for operating the

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sensor 702 in a near field mode, and a second configuration 710 (shown below the line 730) for operating the sensor 702 in a far field mode. Specifically, when the sensor 702 is configured to operate in the near field mode (configuration 708), the following electrodes are configured to operate as transmitters: 712, 716, 720, and 724; and the following electrodes are configured to operate as receivers: 714, 718, 722, and 726. Alternatively, when the sensor 702 is configured to operate in the far field mode (configuration 710), the following electrodes are configured to operate as transmitters: 712, 714, 716, and 718; and the following electrodes are configured to operate as receivers: 720, 722, 724, and 726.

In various embodiments, the processing system may dynamically reconfigure the sensor to selectively operate in the near field mode or the far field mode by changing the function of a plurality of electrodes from that of a transmitter to that of a receiver, or vice-versa. An individual electrode may be selectively employed as either a transmitter electrode or a receiver electrode by connecting that electrode to a corresponding transmitter or receiver circuit within (or otherwise associated) with the processing system. In an embodiment, each individual electrode may be selectively connected to a respective transmitter or receiver circuit. Alternatively, blocks of electrodes may be selectively connected to a common transmitter or receiver circuit.

By way of illustration and without limiting the generality of the foregoing, an exemplary electrode 714 may be connected to an individual terminal 744 of the processing system 704 by a conductive routing trace 740. The terminal 744, in turn, may be connected to a switch 746 (e.g., a multiplexor circuit) either inside or external to the processing system. When it is desired to operate the electrode 714 as a transmitter, the switch 746 connects the electrode, via the terminal 744, to a transmitter circuit 748. When it is desired to operate the electrode 714 as a receiver, the switch 746 connects the electrode, via the terminal 744, to a receiver circuit 7750.

In an embodiment, the various terminals associated with a particular microcontroller bay be grouped into blocks, such as blocks 742 and 743, such that an entire block of terminals may be connected to either the transmitter circuit 748 or receiver circuit 750 through a single switching operation of the switch 746.

In an alternative embodiment, the sensor and processing system of FIG. 700 may be employed in the context of a smart phone, tablet, or other touch screen application as opposed to a traditional keyboard. In particular, the processing system may be configured to dynamically reconfigure the sensor to switch between a low sensitivity, high resolution near field mode for use with an active pen (which has a relatively strong signal), and a high sensitivity, low resolution far field mode for detecting a finger (which has a relatively weak "signal").

FIG. 8 is a schematic diagram of an inter-digitated capacitive sensor superimposed with a graphical representation of an increasing area of contact with a dielectric material for use in a finger detection mode. More particularly, an exemplary capacitive force sensor 800 includes a transmitter node 802 having a plurality of transmitter electrodes 803(a), 803(b), and a receiver node 804 having a plurality of receiver electrodes 805(a), 805(b). In a preferred embodiment, each transmitter and receiver electrode is in the range of 10-100 micrometers (um) thick, and preferably about 50 um, and adjacent electrodes may be separated by a gap 810 of approximately the same dimension.

With continued reference to FIG. 8, a deformable dielectric material exhibits an initial area of overlap 812 with the underlying sensor when the key cap is not activated. The initial contact area 812 may be zero or non-zero. The deformable dielectric exhibits a first area of overlap 814 5 with the sensor during an early stage of a keystroke, and a second area of overlap 816 during a latter stage of the keystroke.

A keyboard input device is thus provided which includes a plurality of key assemblies configured to be pressed by an 10 input object, wherein each of a subset of the key assemblies comprises a key cap and a capacitive sensor disposed underneath the key cap, and a processing system communicatively coupled to and configured to selectively operate each capacitive sensor in a first mode and a second mode, 15 wherein the first mode operates each capacitive sensor in a fine pitch configuration and determines a first variable capacitance, and the second mode operates each capacitive sensor in a coarse pitch configuration and determines a second variable capacitance.

In an embodiment the first mode corresponds to near field detection and the second mode corresponds to far field detection.

In an embodiment, the processing system is further configured to determine at least one of a finger presence 25 proximate the key cap and key cap motion from at least one of the first and second variable capacitances. Key cap motion may be determined based on the first variable capacitance, and finger presence may be determined based on the second variable capacitance.

In an embodiment, the processing system is configured to switch between the first and second modes at a frequency in the range of about 1 to about 50 Hz.

In an embodiment, each of the subset of key assemblies may include a planar translation effecting (PTE) mating 35 feature including a ramp configured such that the key cap translates vertically and laterally in a planar manner relative to the PTE feature in response to the input object contact.

In an embodiment, the processing system may be configvarying duty cycle.

In an embodiment, the capacitive sensor comprises a plurality of parallel conductors separated by a distance in the range of about 50 to about 150 micrometers, wherein the fine pitch configuration comprises an inter-digitated pattern of 45 alternating transmitter and receiver electrodes, and the coarse configuration comprises at least a first subset of adjacent transmitter electrodes and at least a second subset of adjacent receiver electrodes.

In an embodiment, the capacitive sensor includes at least 50 three or four ohmically isolated electrodes, and the processing system includes transmitter circuitry and receiver circuitry and is configured to selectively connect the three electrodes, respectively, to the transmitter circuitry and receiver circuitry.

In an embodiment, the processing system may include an external switch and a microcontroller configured to selectively connect the electrodes to the transmitter circuitry and receiver circuitry using the external switch.

In an embodiment, the processing system is configured to 60 operate in the second mode until a finger is detected, and to time multiplex between the first and second modes in response to detection of the finger.

In an embodiment, a compressible dielectric may be disposed between the key cap and the capacitive sensor, 65 wherein the compressible dielectric and the capacitive sensor exhibit an area of contact which increases during a down

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stroke of the key cap, thereby changing at least the first variable capacitance when in the first mode.

In an embodiment, the area of contact may increase substantially monotonically with downward key cap motion.

A processing system is also provided for a keyboard input device of the type including a plurality of key assemblies each having a key cap and a capacitive sensor disposed underneath the key cap. The processing system is configured to be communicatively coupled to each of the capacitive sensors and configured to selectively operate each capacitive sensor in a first mode and a second mode; wherein the first mode operates the capacitive sensor in a fine pitch configuration and determines a first variable capacitance, and the second mode operates the capacitive sensor in a coarse pitch configuration and determines a second variable capacitance; and wherein key cap motion is determined based on the first variable capacitance and finger presence is determined based on the second variable capacitance.

In an embodiment, the processing system may be config-20 ured to operate in the second mode until a finger is detected. and to time multiplex between the first and second modes in response to the detection of a finger.

In an embodiment, the capacitive sensor may include a plurality of parallel conductors separated by a distance in the range of about 50 to about 150 micrometers, and the processing system may be configured to switch between the first and second modes at a frequency in the range of about 20 to 100 Hz, and preferably about 50 to 100 Hz.

In a keyboard of the type including a key cap and a capacitive sensor disposed underneath the key cap, a method is provided for: operating the capacitive sensor in a first mode configured for near field detection and generating a first variable capacitance; operating the capacitive sensor in a second mode configured for far field detection and generating a second variable capacitance; determining key motion based on the first variable capacitance; and determining finger presence based on the second variable capaci-

In an embodiment, operating the capacitive sensor in the ured to switch between the first and second modes using a 40 first mode may involve configuring the capacitive sensor in a fine pitch arrangement of parallel conductors; and operating the capacitive sensor in the second mode may involve configuring the parallel conductors in a coarse pitch arrangement including a first subset of adjacent transmitter electrodes and a second subset of adjacent receiver electrodes.

> Thus, the techniques described herein can be used to implement any number of devices utilizing different touchsurface assemblies, including a variety of keyboards each comprising one or more key assemblies in accordance with the techniques described herein. Some components may be shared when multiple touchsurfaces are placed in the same device. For example, the base may be shared by two or more touchsurfaces. As another example, the keyswitch sensor may be shared through sharing sensor substrates, sensor 55 electrodes, or the like.

The implementations described herein are meant as examples, and many variations are possible. As one example, any appropriate feature described with one implementation may be incorporated with another. As a first specific example, any of the implementations described herein may or may not utilize a finishing tactile, aesthetic, or protective layer. As a second specific example, ferrous material may be used to replace magnets in various magnetically coupled component arrangements.

In addition, the structure providing any function may comprise any number of appropriate components. For example, a same component may provide leveling, planar

translation effecting, readying, and returning functions for a key press. As another example, different components may be provide these functions, such that a first component levels, a second component effects planar translation, a third component readies, and a fourth component returns. As yet 5 another example, two or more components may provide a same function. For example, in some embodiments, magnets and springs together provide the return function, or the ready and return functions. Thus, the techniques described in the various implementations herein may be used in conjunction 10 with each other, even where the function may seem redundant. For example, some embodiments use springs to backup or augment magnetically-based ready/return mechanisms.

What is claimed is:

- 1. A keyboard input device comprising:
- a plurality of key assemblies configured to be pressed by an input object, wherein each of the plurality of key assemblies comprises a keycap and a capacitive sensor, each keycap for said each key assembly; and
- a processing system communicatively coupled to the plurality of key assemblies and configured to:
 - selectively operate said each capacitive sensor of said each key assembly in a first mode for near field 25 detection and a second mode for far field detection, wherein the first mode operates said each capacitive sensor of said each key assembly in a fine pitch configuration and determines a first variable capacitance, and the second mode operates said each 30 capacitive sensor of said each key assembly in a coarse pitch configuration and determines a second variable capacitance,
 - determine, for said each key assembly of the plurality of key assemblies and from the first variable capaci- 35 tance, a keycap motion of the keycap of said each key assembly, and
 - determine a finger presence proximate to the keycap of said each key assembly from the second variable
 - wherein the fine pitch configuration, of said each capacitive sensor of said each key assembly, comprises an inter-digitated pattern of alternating parallel transmitter and receiver electrodes, and the coarse configuration, of said each capacitive sensor of said 45 each key assembly, comprises at least a first subset of adjacent transmitter electrodes and at least a second subset of adjacent receiver electrodes.
- 2. The keyboard input device of claim 1, wherein the processing system is configured to switch between the first 50 and second modes at a frequency in the range of about 1 to about 50 Hz.
- 3. The keyboard input device of claim 1, wherein said each of the plurality of key assemblies further comprises a planar translation effecting (PTE) mating feature including a 55 ramp configured such that the keycap of said each key assembly translates vertically and laterally in a planar manner relative to the PTE feature in response to the input object
- 4. The keyboard input device of claim 1, wherein the 60 processing system is configured to switch between the first and second modes using a varying duty cycle.
- 5. The keyboard input device of claim 1, wherein said each capacitive sensor of said each key assembly comprises a plurality of parallel conductors separated by a distance in 65 to operate in the second mode until a finger is detected, and the range of about 50 to about 150 micrometers.
 - 6. The keyboard input device of claim 1, wherein:

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- said each capacitive sensor of said each key assembly comprises at least three ohmically isolated electrodes;
- the processing system comprises transmitter circuitry and receiver circuitry, and is further configured to selectively connect the three electrodes, respectively, to the transmitter circuitry and receiver circuitry.
- 7. The keyboard input device of claim 6, wherein:
- the processing system further comprises an external switch and a microcontroller configured to selectively connect the three electrodes, respectively, to the transmitter circuitry and receiver circuitry through the external switch.
- 8. The keyboard input device of claim 1, wherein the 15 processing system is configured to operate in the second mode until a finger is detected, and to time multiplex between the first and second modes in response to detection of the finger.
- 9. The keyboard input device of claim 1, further comwherein each capacitive sensor disposed underneath 20 prising, for said each key assembly, a compressible dielectric disposed between the keycap and the capacitive sensor.
 - 10. The keyboard input device of claim 9, wherein the compressible dielectric and the capacitive sensor of said each key assembly exhibit an area of contact which increases during a down stroke of the keycap of said each key assembly, thereby changing at least the first variable capacitance when in the first mode.
 - 11. The keyboard input device of claim 10, wherein the area of contact increases substantially monotonically with downward the keycap motion.
 - 12. A processing system for a keyboard input device comprising a plurality of key assemblies, each key assembly of the plurality of key assemblies comprising a keycap and a capacitive sensor, wherein each capacitive sensor disposed underneath each keycap for said each key assembly, wherein the processing system is configured to be communicatively coupled to the plurality of key assemblies, and configured to perform functionality comprising:
 - selectively operating said each capacitive sensor of said each key assembly in a first mode for near field detection and a second mode for far field detection, wherein the first mode operates said each capacitive sensor of said each key assembly in a fine pitch configuration and determines a first variable capacitance, and the second mode operates said each capacitive sensor of said each key assembly in a coarse pitch configuration and determines a second variable capaci-
 - determining, for said each key assembly of the plurality of key assemblies and from the first variable capacitance, a keycap motion of the keycap of said each key assembly, and
 - determining a finger presence proximate to the keycap of said each key assembly from the second variable capacitance,
 - wherein the fine pitch configuration, of said each capacitive sensor of said each key assembly, comprises an inter-digitated pattern of alternating parallel transmitter and receiver electrodes, and the coarse configuration, of said each capacitive sensor of said each key assembly, comprises at least a first subset of adjacent transmitter electrodes and at least a second subset of adjacent receiver electrodes.
 - 13. The processing system of claim 12, further configured to time multiplex between the first and second modes in response to the detection of a finger.

- 14. The processing system of claim 12, wherein the capacitive sensor of said each key assembly, comprises a plurality of parallel conductors separated by a distance in the range of about 50 to about 150 micrometers, and further wherein the processing system is configured to switch 5 between the first and second modes at a frequency in the range of about 50 to 100 Hz.
- 15. A method for operating a keyboard comprising a plurality of key assemblies, wherein each key assembly of the plurality of key assemblies comprising a keycap and a 10 capacitive sensor, wherein each capacitive sensor disposed underneath each keycap for said each key assembly, the method comprising:
 - selectively operating said each capacitive sensor of said each key assembly in a first mode configured for near 15 field detection and a second mode configured for far field detection, wherein the first mode operates said each capacitive sensor of said each key assembly in a fine pitch configuration and determines a first variable capacitance, and the second mode operates said each

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- capacitive sensor of said each key assembly in a coarse pitch configuration and determines a second variable capacitance;
- determining, for said each key assembly of the plurality of key assemblies, and from the first variable capacitance, a keycap motion of the keycap of said each key assembly; and
- determining a finger presence proximate to the keycap of said each key assembly from the second variable capacitance,
- wherein the fine pitch configuration, of said each capacitive sensor of said each key assembly, comprises an inter-digitated pattern of alternating parallel transmitter and receiver electrodes, and the coarse configuration, of said each capacitive sensor of said each key assembly, comprises at least a first subset of adjacent transmitter electrodes and at least a second subset of adjacent receiver electrodes.

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